



PST ZK322

FAST RECOVERY DIODE

Features

- Blocking Capability up to 1600 V
- Soft Reverse Recovery
- Rugged Ceramic Hermetic Package

ELECTRICAL CHARACTERISTICS AND RATINGS

Blocking

Parameter	Symbol	Min	Max	Typ	Unit	Conditions
Repetitive peak reverse voltage	V_{RRM}		1600		V	$T_j = -40^\circ C$ to $125^\circ C$
Non repetitive peak reverse voltage	V_{RSM}		1700		V	$T_j = -40^\circ C$ to $125^\circ C$
Repetitive peak reverse current	I_{RRM}		50		mA	$T_j = T_{jmax}$, $V = V_{RRM}$

Conducting

Parameter	Symbol	Min	Max	Typ	Unit	Conditions
Average value of forward current	$I_{F(AV)}$		590		A	50 Hz sinewave, 180° conduction, $T_c = 85^\circ C$
RMS value of forward current	$I_{F(RMS)}$		926		A	50 Hz sinewave, 180° conduction, $T_c = 85^\circ C$
Peak one cycle surge (non repetitive) current	I_{FSM}		11.5		kA	50 Hz sinewave, 180° conduction, $T_j = T_{jmax}$, $V_R = 0$
I^2t	I^2t		661		kA ² s	$T_j = T_{jmax}$
Peak forward voltage	V_{FM}		1.49		V	Forward current 1200 A, $T_j = T_{jmax}$
Threshold voltage	$V_{F(TO)}$		0.88		V	$T_j = T_{jmax}$
Forward slope resistance	r_F		0.51		mΩ	$T_j = T_{jmax}$

Thermal and mechanical characteristics and ratings

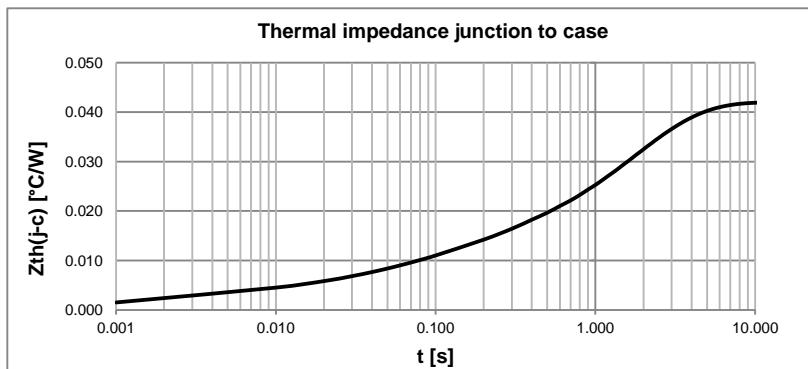
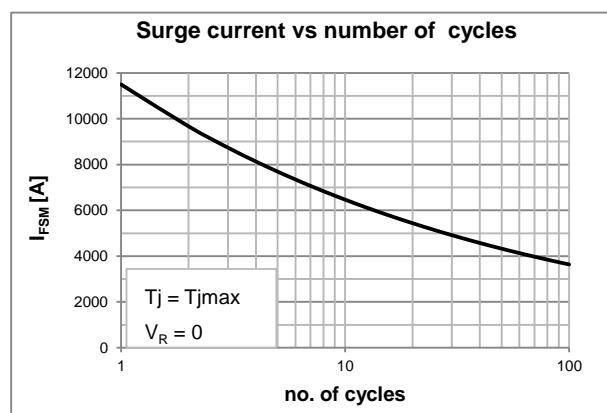
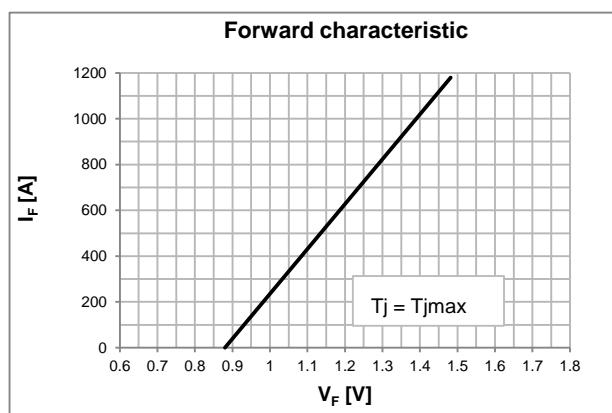
Parameter	Symbol	Min	Max	Typ	Unit	Conditions
Operating temperature	T_j	-40	125		°C	
Storage temperature	T_{stg}	-40	125		°C	
Thermal resistance junction to case	$R_{th(j-c)}$		0.042		°C/W	Double side cooled, 180° SIN
Thermal resistance case to sink	$R_{th(c-s)}$		0.010		°C/W	Mounting surfaces smooth, flat and greased
Mounting force	F	8.5	9.5		kN	
Weight	W			280	g	

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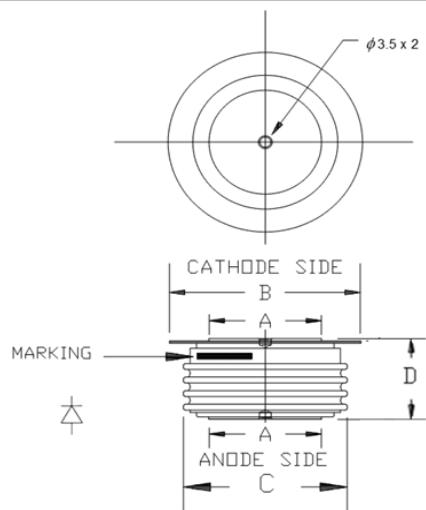
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Switching

Parameter	Symbol	Min	Max	Typ	Unit	Conditions
Reverse recovery current	I_{rr}		70		A	$I_F = 1000 \text{ A}$
Reverse recovery charge	Q_{rr}		60		μC	$dI_F / dt = 60 \text{ A}/\mu\text{s}$
Reverse recovery time	t_{rr}		2.0		μs	$V_R = 50 \text{ V}$
Softness	s	0.5				$T_j = T_{jmax}$



OUTLINE AND DIMENSIONS



	A	B	C	D
mm	34	56 - 64	55	26 ± 1

- All the characteristics given in this data sheet are guaranteed only with uniform clamping force, cleaned and lubricated heatsink surfaces with flatness < 0.03 mm and roughness < 2μm